

General Description

The OCH1660 Omnipolar Hall effect sensor IC is fabricated from mixed signal CMOS technology. It is comprised of two Hall plates and a CMOS output driver, mainly designed for battery-operation. The total power consumption in normal operation is typically 9μ W with a 3V power source. either north or south poles of sufficient strength will turn the output on. The output will be turned off under no magnetic field. While the magnetic flux density (B) is larger than operating point (BOP), the output will be turned on (low), the output is held until B is lower than release point (BRP), and then turned off.

The OCH1660 is available in many flexible packaging options, such as SOT23-3L/SIP-3L. Operating temperature range of the OCH1660 is from -40°C to 85°C.

Features

- 3uA Micro power design
- 2.4V to 5.5V battery operation
- CMOS Output
- Operation with North or South pole(omnipolar)
- High sensitivity and high stability of the magnetic switching points
- High resistance to mechanical stress
- Digital output signal
- Good RF noise immunity
- -40°Cto 85°Coperating temperature
- SOT23-3L/SIP-3L(TO92S) package

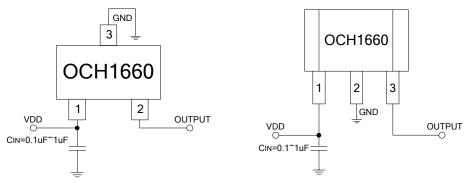
Applications

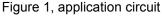
- Smart meter
- toys
- Cover switch in Notebook PC/PDA
- Contact-less switch in consumer products
- Solid State Switch
- Handheld Wireless Handset Awake Switch
- Lid close sensor for battery-powered devise

| Vcc 1 | 3 GND OUTPUT 2 | | OUTPUT GND Vcc | | |
|-------------|-------------------------|--------|---|--|--|
| SOT23-3L SI | | | SIP-3L(TO92S) | | |
| Pin Name | Pin | | Description | | |
| Fill Name | SOT23-3L | SIP-3L | Description | | |
| VCC | 1 | 1 | IC Power Supply | | |
| OUTPUT | 2 | 3 | It is low state during the S/N magnetic field | | |
| GND | 3 | 2 | IC Ground | | |

(Top View)

Application Circuit





Note: C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 0.1~1uF.





Ordering Information

| Part Number | Package Type | Packing Qty | Bop (Gauss) | B _{RP} (Gauss) | Temperature | Eco Plan | Lead |
|-------------|--------------|--------------|-------------|-------------------------|-------------------|----------|------|
| OCH1660WAD | SOT23-3L | 3000pcs/Reel | ±20(Typ.) | ±14(Typ.) | -40~ +85℃ | ROHS | Cu |
| OCH1660MD | SIP-3L | 1000pcs/Bag | ±20(Typ.) | ±14(Typ.) | -40∼ +85 ℃ | ROHS | Cu |

Block Diagram

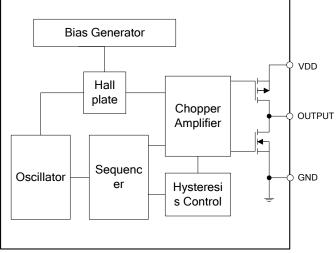


Figure 2, Block Diagram Of OCH1660

• Absolute Maximum Ratings¹ (T_A=25°C unless otherwise noted)

| Parameter | | Symbol | Rating | Unit |
|--|----------|-------------------|-------------|------|
| VDD to GND | | Vcc | -0.3 to 6 | V |
| Magnetic Flux Density | | В | Unlimited | |
| Storage Temperature Range | | Ts | -65 to +150 | °C |
| Operating Junction Temperature Range | | TJ | -40 to 150 | °C |
| Maximum Power Dissipation | SOT23-3L | PD | 230 | mW |
| | SIP-3L | | 300 | |
| Maximum Soldering Temperature (at leads, 10 sec) | | T _{LEAD} | 260 | |

■ **Recommended Operating Conditions** (T_A=25°C unless otherwise noted)

| Parameter | Symbol | Conditions | Rating | Unit |
|-----------------------------|-----------------|------------|-----------|------|
| Supply Voltage | V _{DD} | Operating | 2.4 ~ 5.5 | V |
| Operating Temperature Range | TA | Operating | -40 ~ +85 | °C |

15